KEK activities on CLIC X-band Accelerating Structures

Tsinghua Univ., March 24 T. Higo (KEK)

Contents

- Basic idea behind KEK X-band R&D
- History of X-band developments at KEK
- Preparation of test structures
- Test facilities
- Test results of accelerating structures
- Expansion of Nextef facility
- Basic studies related to breakdown
- Expansion of our collaboration

Areas of concern for KEK X-band R&D

- LC before ITRP and extension to LCrelated study with CLIC
- X-band Application
- Basic technology for high energy accelerator
- Scientific understanding of processing and breakdowns

History of X-band developments at KEK

- Early 1990: High precision machining + diffusion bonding
 - Establishment of fabrication technology \rightarrow 1.3m DS
- Late 1990: realized discharge problem
 - Reduce group velocity, shorter str.
- By 2004 ITRP: 60cm HDDS
 - Eacc established 50~65MV/m
 - HOM suppression: HDDS weak damping + detuning
- 2007~: CLIC→X-band & higher gradient
 - collaboration CERN+SLAC+KEK
 - 30cm TW acc structure

Relevant accelerator structures

Stage	Unit	JLC-X	GLC	CLIC-C	CLIC-G
Year		1996	2004	2007	2010
Есм	TeV	1	1	3	3
Structure	Туре	DS	HDDS	CG / HDS	HDS
Length	m	1.3	0.6	0.2	0.3
Eacc	MV/m	73 / 60	65 / 50	120 / 100	120 /100
PIN	MW	130	57	65	64
<a λ="">		0.2~0.14	0.2 ~ 0.15	0.15~0.08	0.12~0.09
Vg/c	%	10 ~ 2	4.5~0.8	2.4~0.7	1.7~0.8
ΔΤ	°C		< 19	71	53

Some typical experiments in mind

- High gradient characteristics only reflects the material choice!?
 - After processing
 - After number of breakdowns
 - After saturation
- Is this true?
 - Not electric field but magnetic field is the key?
 - Surface treatment is not the issue?
 - Hard/soft may or may not be the issue?

Single-cell SW high gradient test at SLAC Surface treatment is not the issue??

ultra clean condition VS normal surface processing conditions.



The near perfect surface processing affected only the processing time. The second structure processed to maximum gradient in few minutes vs few hours for the normally processed structure.

But we are curious how the processing proceeds and how high we can obtain without serious damage.





100310, TD18_Disk_#3 Faya Wang, SLAC

BDR Pulse Heating Dependence



Walter Wuensch, CLIC09



- Higher initial E Higher initial E_{BRD} and concurrence properties of break of b surface property is lost and An oxide layer has been grow • Has also a different E_{LOC} as t totally determined by the surface property is loss that totally determined by the surface property is totally determined



E_{BRD}=350-500 MV/m in both cases This lasts only for 15-20 sparks (left case) or 20-40 sparks (right case)



CLIC workshop 2009

(Higo)

General idea behind our study

- Take these experimental results in mind.
- Before reaching this saturated regime, there should be a place to play with the surface condition or crystal structure.
- Can we stay in this regime for high gradient?
- How to proceed through this regime to saturation?
- Inevitable to go beyond this regime for high gradient?
- Want to study the performance from this view point.
- Then we understand and conclude in which regime we play for the linear collider.
- One of the key issues for our studies is devoted to this point, in addition to pursuing higher and higher gradient.

Preparation of accelerator structures

- Technology established as of GLC/NLC era
 - KEK precision machining of parts
 - SLAC assembly
 - Now further study is ongoing with SLAC and CERN to improve in future
- Fabrication flow
 - Precision machining
 - Chemical polish
 - Diffusion bonding and brazing in hydrogen furnace
 - Baking in vacuum at 650C

Fabrication of damped structures



KEK fabricated all parts.



SLAC made assembly.

Vacuum Baking of T18_vg2.4_DISC



650° C 10 days at SLAC

TD18 first pair #2(KEK) & #3(SLAC)





#3 being tested at SLAC NLCTA

#2 being tested at KEK Nextef



Structure test philosophy

- Evaluate at more than one laboratory
 - Independent evaluation
 - Equivalent to "S0" idea for ILC
 - Obtain statistical info and cross checking
- Requirement for facility
 - Long-term operation
 - 100MW or more power for over 100MV/m level
- Actual facilities
 - SLAC NLCTA with pulse compression
 - KEK Nextef with two klystrons
 - CERN 12GHz being developed
 - The comparison of three independent studies is a healthy condition, which should be kept.

Test facilities of KEK



Now located at the J-Arc of the KEKB Injector

CLIC collaboration meeting at Tsinghua U.

KEK test facilities

- Nextef
 - Shield-A being used for structure tests
 - Shield-B being prepared for basic studies, taking power from KT-1
- KT-1
 - One PPM klystron
 - High gradient study with narrow waveguide
 - High power study on components
 - Feed shield B

KEK: Nextef Configuration



Nextef operation since 2007





CLIC collaboration meeting at Tsinghua U. (Higo)

Nextef inside shield room



Monitors and components in shield-A



High gradient test of three structures

- Disk-based un-damped
 - T18_Disk Oct. 2008~June 2009
 - 4000hr, 9 months
- Quad-based heavily damped
 - TD18_Quad_#5 Sep. 2009~Nov. 2009
 - 1000hr, 3 months
- Disk-based heavily damped
 - TD18_Disk_#2 Dec. 2009~
 - 1200hr, 4 month+

T18_Disk_#2

- Aim
 - Electric gradient: possibility to realize 100MV/m within tolerable breakdown rate
- Design geometry
 - No damping slots
 - Big increase of gradient toward downstream
 - No big pulse heating temperature rise



20100324

CLIC collaboration meeting at Tsinghua U.

(Higo)

T18_Disk #2(KEK)

090610

MasterTable_Eacc_Trend till_090610



Establishment of experiments to quantitatively compare SLACで試験



BKD Possibility for 230ns

#2 KEKで試験





HG@ANL, 2009

Roughly the same breakdown rates were observed for a pair of structures. Will pursue the same comparison again for the second pair.

CLIC collaboration meeting at Tsinghua U.

20100324

(Higo)

Breakdown position for 205 ns data



Red real cell timing, blue linear cell timing, 205 ns data

Dark current evolution 252nsec



Measured at RF ON 700 - 1200 - 2100 - 3000 - 3400 hours Decreasing amount, no big change in shape nor slope (beta).

(Higo)

Dark current spectra in June



Actual field of analyzer magnet was checked.

The formula used up to now $pc[MeV/m] = 1.646 \times I[A] = 8.23 \times Ref.$ Volt. [V] was confirmed.

Two peaks appear and higher for higher momentum one.

Less than ½ of full acceleration.

Little exists below 2.5MeV/m.

09



Optical inspection upstream and downstream



Insertion 82.7mm Iris #1 at match cell

Insertion 98.0mm 252.2mm Iris #19 Iris #2 at first Down side iris of last regular cell CLIC collaboration regular cell CLIC collaboration regular cell



261.3mm Last regular cell iris #20

Optical inspection result and future

- No significant variation as cell position was observed
 - Though more breakdowns happened downstream end estimated from RF pulse shape
- Need to inspect with better spacial resolution
 - Change to better bore scope or adjust focal plane?
 - Should be inspected by SEM

As of completion, meas. By J. Lewandowski

0.06

0.0

0.02

-0.02

• -0.04

-0.06

-0.08



15



0.05

20100324

5

10

CLIC collaboration meeting at Tsinghua U.

(Higo)

Bead pull amplitude plot 11422MHz after high gradient test



Phase and frequency after high gradient test


RF change due to high gradient test

- RF evaluated after high gradient test for 4000 hours with 2500 breakdowns in 800M pulses.
 - Input matching was kept.
 - Output matching changed by Γ =0.05 level.
 - Average frequency increased by 1.1+0.7=+1.8MHz.
 - Field ripple ±4.4% appeared near output end.
- Above change in RF performance was observed.
 - Need to confirm carefully with SLAC data.
 - If this is due to the actual structure change, not tolerable. → Need the number of breakdowns be limited until reaching operation.

T18_Disk summary

- 100MV/m was proven to be feasible
- Similar breakdown rate between SLAC and KEK
- Breakdown rate decreased as processing proceed
- Breakdown probability is higher in downstream cells
- Dark current can be fit with modified FN formula
- Dark current decreases as processing proceeds
- No big change in field enhancement value
- Dark current dominates in low energy region, from a few down-stream cells
- RF property seems changed due to the processing
- Long-term operational stability should be proven

TD18_Quad_#5

- Aim
 - Study the structure split in longitudinal plane
 - Taste the one with 50 micron radius at the edge
- Design geometry
 - Large damping aperture
 - Big increase of gradient toward downstream
 - Big pulse heating temperature rise at the damping port opening

KEK's version: 50 micron chamfer





Made of CuZr without heat treatment.

50 micron rounding: shape with angles and bumps.

Reference planes were formed by milling in a few micron level without re-chucking for shaping cells.

Assembly was done within ten micron level.

Possible cause of high dark current Field enhancement due to round chamfer

- Simulation of field enhancement
 - 1.4 ~ 1.6 at radius
 - with gap<radius/5, step<radius/2.5</p>
- Only a few tool passes
 - to shape 50 micron radius
 - with radius tool of 2mm
 - If three passed → tangential discontinuity by about 30 degree
 - Can be relaxed by such as EP in future

Detailed shape at R0.05 chamfer



Only 2~3 tool passes over R0.05 90deg rounding.

Not tangential connection from smooth surface. 30-40 degree edge emerges.

Sharp edges or bumps exist at the rim.

Electric field enhancement in a shallow channel with round chamfer

Calculation done by T. Abe by CST MS. Waveguide field.





Gap (micron)	Bump (micron)	Emax / Enominal
0	0	1.39
0	20	1.57
10	20	1.58
CLIC collaboration meeting at Tsinghua U.		

20100324

Production of quadrant Q1-1



Surface: No etching No high-temperature heat treatment

- Alcohol bath
 - with ultra-sonic vibration for 5 minutes.
- Acetone bath twice
 - with ultra-sonic vibration for 5 minutes.
- Nitrogen blow
- Storage in a deccicator
 - Initially filled with nitrogen gas.
 - Storage for more than a month.

Assembly



Carry and storage



First hanging



Prepare next quad approach





Edge inspection

20100324

Check ball diameter

CLIC collaboration meeting at Tsinghua U.

(Higo)

Second hanging



Fine adjustment





Completion of stack



Alignment checking



Fixing by bolt

Manual adjustment before final pressing, without ball and groove mechanism. Misalignment: within ten microns.

RF setup

Reproducibility: a few microns. CLIC collaboration meeting at Tsinghua U. 20100324 (Higo)

Final alignment

Misalignment of each quadrant w.r.t. the average of four quadrants (units are in micron)





∧ Y



Elastic tuning with a ball being kept push



4mm stainless ball pushed by minus watch driver. Pushing by turning with Higo's hand full force. Elastic deformation kept, meaning that the tuning pins are kept pushing the balls.

Notice: Deformed cavity wall



Cell 3(× 35)



Cell 8(× 35)



Cell 10(× 35)

Cell 10(×100)

Cell10 no tuning



Cell 3(× 100)

Cell3 deformation: 0.053mm



Cell 8(× 100)

Cell8 deformation: 0.167mm

CLIC collaboration meeting at Tsinghua U. (Higo)

20100324

Field smoothness after tuning good.



20100324

Vacuum chamber design





U-tight seal (round metal gasket) VCR connector for cooling water connection Thin H-bend being vac sealed with bellows Vac evacuation from CF114 mounted on chamber with IP 70I/s and from WR90 at just 0.5m from structure CLIC collaboration meeting at Tsinghua U.

20100324

Installation into chamber







Installed into Nextef

Input connection



at Tsinghu

aboration me

Quad #5 Whole Processing



Gradient limited at 50~60MV/m



ACC-IN pulse at hard limit



CLIC collaboration meeting at Tsinghua U.

Vacuum characteristics

- Vacuum total pressure
 - Base pressure at <10⁻⁶Pa
 - Typically processing <10⁻⁵Pa
 - Increases every time at few to 5MW range if after RF-OFF for more than several hours
- Mass spectrum
 - M=2, 28 and 44 increase with RF-ON, but not M=18
 - Especially when reaching power limit
 - M=2 becomes dominant residual gas after an hour or so run
 - M=27 and 28 change in a similar manner as time, indicating hydrocarbon-origin surface contamination

Breakdown pulse analysis



Timing distribution for change>2000



Tr nsec (Tr change>2000)



T18 structure Function F[z] time difference for the BD info to reach both ends



Use time difference Rs(rise)-Tr(fall) to calculate BD position. Function F(z) is calculated from design vg(z).

Breakdown cell distribution >2000



534 events were analyzed out of 1919 INTLK.

CLIC collaboration meeting at Tsinghua U.

Quad dark current much larger than T18





(Note: Power is just the value in the control program panel. Read 12MW as 19MW, though relative comparison between quad and T18_disk is OK without this.)

CLIC collaboration meeting at Tsinghua U.

20100324

Spectrum peak at very low energy

090926



T18_Disk Peaks at 8MeV/c and 4MeV/c with 108MV/m

Present quad Peak at 1.2MeV/c (=0.8MeV) with 19MW → 59MV/m

It seems only the last cell or +1 contributes mostly.

CLIC collaboration meeting at Tsinghua U.

Inspection with long-distance microscope after finishing high gradient test







No.18 Q2-2 to match Q1-1







Surface inspection summary

- Optical inspection with long-distance focus microscope
- Still not easy to see the arcing spots
- Will go to SEM
 - though only the center of the rod can be observed in a Japanese company in April
- Will go to CERN SEM for full inspection

68

TD18_Quad summary

- Very slow processing
- Hard ceiling in processing gradient
 - 60MV/m @ 50ns, 50MV/m @ 113ns
- No further progress with EP (SLAC)
- Gas trapping at mating surfaces?
- Discharge due to edge? \rightarrow arc is not only at the edge
- We do not understand why these longitudinal split ones are not well in high gradient performance
- Still worthwhile to study because of the estimated cheapness in mass production
- Probably reasonable to test with CD10-type setup

TD18_Disk_#2

- Aim: Prove heavily damped structure
 - Electric gradient: possibility to realize 100MV/m
- Design geometry
 - Heavy damping slots with wide opening
 - Big increase of gradient toward downstream
 - Big pulse heating temperature rise at the damping port opening
 - No longitudinal cut but disk-based as T18 structures
- Fabrication in practice
 - Milling surface in many places
 - CP and VAC baking are the same as T18

70





TD18_Disk_#2 Eacc, Pulse width and # of breakdowns ²⁰¹⁰⁰³¹⁸
Disk-based: un-damp vs heavy damp



50ns, 113ns, 173ns, 213ns, 253ns T18_#2 TD18_#2(50ns)

CLIC collaboration meeting at Tsinghua U.

Breakdowns localized at downstream

20100221



CLIC collaboration meeting at Tsinghua U. (Higo)



1/Es(MV/m)

CLIC collaboration meeting at Tsinghua U.

(Higo)





CLIC collaboration meeting at Tsinghua U. (Higo)

TD18_Disk_#2 test in practice

- Replacing load(L)
 - Acc str BD originated from the BD from the load line disappeared.
- Processing at 50 nsec
 - Reached 100MV/m after 1200hrs with 6000 breakdowns.
 - Still slow processing speed
- Pulse width increased up to 152nsec
 - Roughly the same power level as that of 51ns was reached without difficulty
 - It means 100MV/m level was achieved at longer pulse.
- Power was calibrated with the present setup
 - Peak power meter was used as a reference
 - Kly comb. (S+N) and ACC-IN power were calibrated.

77

TD18_Disk summary

- The processing speed is very slow comparing to that of T18_Disk_#2 or SLAC for TD18_#3.
 - Difference in trip criteria?
 - Difference in acc structure itself?
 - Difference in processing protocol?
 - Need quantitative comparison in detail
- Dark current level reached the similar level to that of T18_Disk_#2.
- Even though the processing seems still proceeding, it may be stopped sometime not very far away but after trying some experimental important studies.

Possible tests with RF shaping



More breakdown in the second pulse? Same dark current for both? Almost independent? Twice processing speed?

TD18_Disk test idea in near future

- Evaluate performance with a longer pulse width
- Study with such as two-pulse operation
- Check dark current evolution to the final saturation
- Finish and go next test

Improvement in Nextef studies

• Much room for anyone to help us

Evaluation of missing energy to be implemented



Pulse analysis, such as missing energy evaluation is still to be established. Good manpower is needed.

CLIC collaboration meeting at Tsinghua U.

Rs Phase measurement to be established BD pulse with IQ



Pulse analysis is still to be established. Good manpower is needed.

FC-UP and FC-Mid



Relation to RF can be better analyzed?

KEK operation plan Nextef & KT1



(Higo)

Nextef expansion plan



Configuration of the Power Line from KT-1 to shield-B





CLIC collaboration meeting at Tsinghua U.

PPM klystron output power limit



CLIC collaboration meeting at Tsinghua U.

PPMクライストロンの運転限界

The availability of ppm klystron depends on the required RF quality. Empirically we have known that RF pulses were often broken when the product of the pulse width and peak power is large.



Example of RF Pulse Waveforms: Normal(Left) and Pulse Shortening (Right).

Pulse Compressor (circular TE11 / TE21) proposed by M. Yoshida.





Some area on basic high gradient studies with KT-1

- Narrow waveguide
- FE microscope and/or DC-HV breakdown
- C10/CD10 TW small setup
- Single-cell setup as SLAC

 These themes are to be prioritized through discussion among us

92

High gradient study with narrow waveguide at KEK



Materials are compared with breakdown rates. Copper BDR >> Stainless-steel BDR We may try molybdenum next.

CLIC collaboration meeting at Tsinghua U. (Higo)

Establish a shield-B for basic studies

- We keep collaborating with SLAC single-cell SW activities
- But also we establish Shield-B connecting to KT-1 in 2010
- Shield-B is originally used for C-band but we can use it for X-band. X-band can coexist with C-band or it may be used for multi-frequency experiment in future.

X-band collaboration



Conclusion

- Nextef will run fully dedicated for the feasibility study of CLIC 100MV/m
- Nextef will boost peak power and high power stability by introducing pulse compression system in 2010
- We try to construct a test area in addition for key studies in a simpler configuration
- From these tests and design efforts, we want to confirm the feasible design as of NOW.
- Let us effectively collaborate among us, especially expanding in Asian collaboration for KEK to contribute